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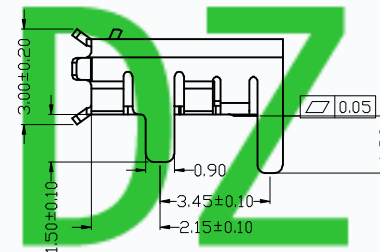
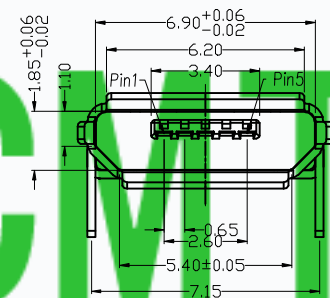
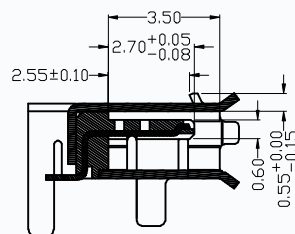
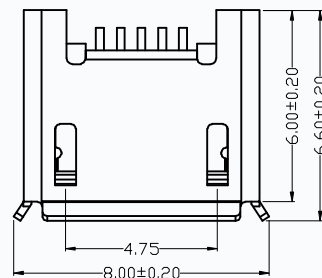
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REV.	ECN NO.	DESCRIPTION	DRWN	APPD.	DATE



NOTES:

MATERIAL:

1.1 HOUSING: HIGH TEMPERATURE THERMOPLASTIC WITH G.F., UL94v-0

1.2 CONTACT: COPPER ALLOY T=0.15mm

1.3 SHELL: COPPER ALLOY, T=0.25mm

2.SPECIFICATION:

2.1 CURRENT RATING: 1 A MAX

2.2 DIELECTRIC WITHSTANDING

VOLTAGE: 100 V(ac) FOR 1min

2.3 CONTACT RESISTANCE: 30 mΩ MAX.

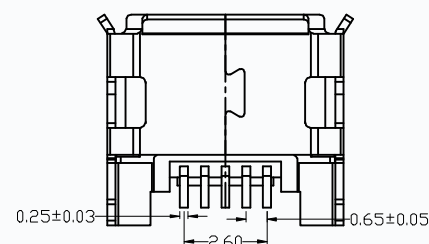
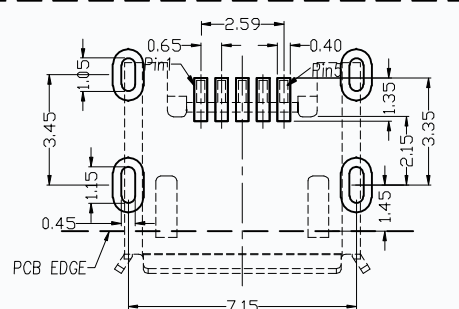
2.4 INSULATION RESISTANCE: 100 MΩ MIN.

2.5 TOTAL MATING FORCE: 3.57 Kgf MAX.

2.6 TOTAL UNMATING FORCE: 1.0Kgf MIN. 0.81~2.05 Kgf

MIN. AFTER 10000 INSERTION/EXTRATION CYCLES

2.7 TEMPERATURE RANGE: -30°C~+80°C



BOM:

項次	料号	名稱	材質	表面	數量
3		外壳	黃銅 (C2680 H), T=0.25±0.03mm	鍍鎳	1
2	DC-005F09-02	胶心	LCP UL 94V-0	黑色	1
1	DC-005F09-01	PIN	黃銅 (C2680 H), T=0.15±0.02mm	鍍前金后錫	5

UNITS	SCALE	REV.	SHEET	东莞市田都电子有限公司	
mm	1:1	X1	1 OF 1	DONGGUAN TIANDU ELECTRONICS CO.,LTD TEL:0769-85384807 FAX:0769-85384842	
DATE		2012-11-16		TITLE:	
DR.		M C		Micro USB 5P/F B 四脚全插 (L=1.80) 无柱卷边	
CHK.		MAT'L		SEE NOTES	FINISH SEE NOTES
APPD.		MODEL NO. p2		PART NO.	SIZE
		T10-05FB13		A	CMTD-MC-B-05-715-018-W AA